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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# 1.0A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER PowerDI®123

#### **Features**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- Lead Free Finish, RoHS Compliant (Note 4)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: PowerDI<sup>®</sup>123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (23)
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	141	V
Average Forward Current	I <sub>F(AV)</sub>	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	40	А

## **Thermal Characteristics**

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Ambient (Note 1)	$R_{\theta JA}$	132	_	°C/W
Thermal Resistance Junction to Soldering Point (Note 2)	$R_{\theta JS}$	_	7	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to	+175	°C

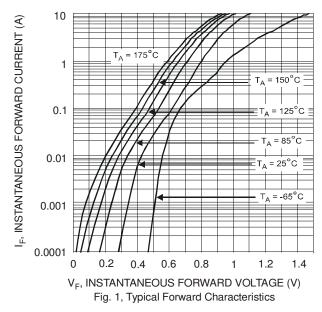
# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

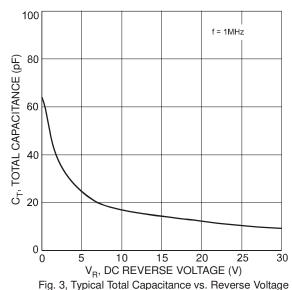
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 3)	$V_{(BR)R}$	200		_	V	$I_R = 8\mu A$
Forward Voltage	$V_{F}$	_	_	0.85	V	$I_F = 1.0A$
Leakage Current (Note 3)	I <sub>R</sub>			2	μΑ	$V_R = 200V, T_A = 25^{\circ}C$
Total Capacitance	Ст		23	_	рF	$V_R = 5VDC$ , $f = 1MHz$

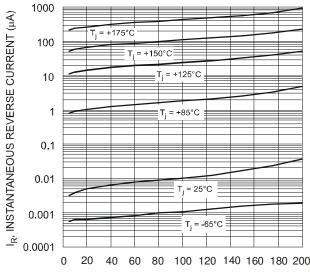
#### Notes:

- Part mounted on FR-4 board with 2 oz., minimum recommended copper pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. T<sub>A</sub> = 25°C
- 2. Theoretical  $R_{\text{NJS}}$  calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
- 3. Short duration pulse test used to minimize self-heating effect.
- 4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

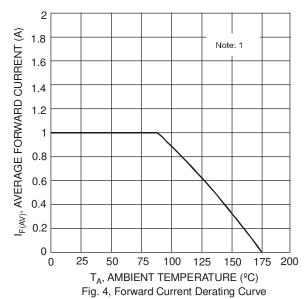








V<sub>R</sub>, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2, Typical Reverse Characteristics

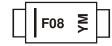


## Ordering Information (Note 5)

Part Number	Case	Packaging		
DFLS1200-7	PowerDI®123	3000/Tape & Reel		

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



F08 = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: R = 2004) M = Month (ex: 9 = September)

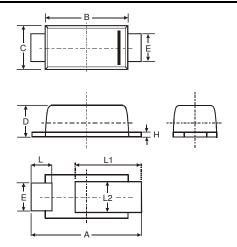
Date Code Key

Year	2004	20	005	2006	2007	20	80	2009	2010	20	11	2012
Code	R		S	T	U	\	<b>V</b>	W	X	`	Y	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

PowerDI is a registered trademark of Diodes Incorporated.

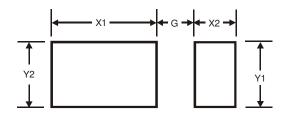


## **Package Outline Dimensions**



PowerDI <sup>®</sup> 123					
Dim	Min	Max	Тур		
Α	3.50	3.90	3.70		
В	2.60	3.00	2.80		
С	1.63	1.93	1.78		
D	0.93	1.00	0.98		
Е	0.85	1.25	1.00		
Н	0.15	0.25	0.20		
L	0.55	0.75	0.65		
L1	1.80	2.20	2.00		
L2	0.95	1.25	1.10		
All D	All Dimensions in mm				

## **Suggested Pad Layout**



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4

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